

# PRM6R0N06CT

# PFC Device Corporation

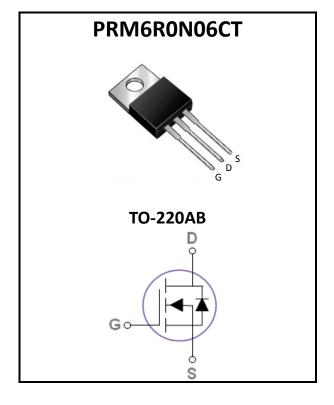
# 60V Single N-Channel MOSFET

## Major ratings and characteristics

Characteristics	Values	Units
V <sub>DS</sub>	60	V
I <sub>D</sub> <sup>6</sup> (T <sub>C</sub> =25°C)	134	Α
Max. R <sub>DS(ON)</sub> @V <sub>GS</sub> =10V	6.0	mΩ
Max. $R_{DS(ON)}@V_{GS}=4.5V$	10.0	mΩ
T <sub>J</sub> Operating Junction Temperature	-55 to +150	°C

## **General Description**

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.



## **Typical Applications**

- Charger Adapter
- Power Tools
- LED Lighting

## Features

- Max. R<sub>DS(ON)</sub>=6.0mΩ@V<sub>GS</sub>=10V
- Improved dv/dt capability
- Fast switching
- 100% E<sub>AS</sub> Guaranteed
- Green Device Available

Version 4.0

## **1.** Characteristics

### Maximum Ratings Characteristics

( $T_A = 25$  °C unless otherwise specified)

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	60	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
$I_D^5$	Drain Current – Continuous (T <sub>C</sub> =25°C)	134	А
١D	Drain Current – Continuous (T <sub>C</sub> =100°C)	85	А
$I_D^6$	Drain Current – Continuous (T <sub>c</sub> =25°C)	60	А
I <sub>DM</sub>	Drain Current – Pulsed <sup>1</sup>	240	А
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>2</sup>	39	mJ
I <sub>AS</sub>	Single Pulse Avalanche Current <sup>2</sup>	28	А
	Power Dissipation (T <sub>C</sub> =25°C)	169	W
PD	Power Dissipation – Derate above 25°C	1.35	W/°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	C°

### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction to ambient		60	°C/W
$R_{ extsf{ heta}JC}$	Thermal Resistance Junction to Case		0.74	°C/W



### **Electrical Characteristics**

( $T_J = 25$  °C unless otherwise specified)

Off	Chara	cteristics
-----	-------	------------

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	60			V
	Drain Source Leekage Current	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C			1	uA
IDSS	Drain-Source Leakage Current	V <sub>DS</sub> =48V, V <sub>GS</sub> =0V, T <sub>J</sub> =100°C			100	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA

#### **On Characteristics**

D	Static Drain-Source	V <sub>GS</sub> =10V, I <sub>D</sub> =20A		5.0	6.0	mΩ
R <sub>DS(ON)</sub>	On-Resistance	V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A	,	6.6	10.0	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_{D}=250uA$	1.2	1.7	2.5	V
<b>g</b> <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =20A		57		S

#### **Dynamic and switching Characteristics**

$Q_{g}$	Total Gate Charge <sup>3, 4</sup>	V <sub>DS</sub> =30V, V <sub>GS</sub> =10V, I <sub>D</sub> =20A	 35	
$Q_{gs}$	Gate-Source Charge <sup>3,4</sup>		 7.2	 nC
$Q_gd$	Gate-Drain Charge <sup>3,4</sup>		 5.4	
T <sub>d(on)</sub>	Turn-On Delay Time <sup>3, 4</sup>		 28	
Tr	Turn-On Rise Time <sup>3, 4</sup>	V <sub>DD</sub> =30V, V <sub>GS</sub> =10V, R <sub>G</sub> =10Ω I <sub>D</sub> =20A	 45	 20
T <sub>d(off)</sub>	Turn-Off Delay Time <sup>3, 4</sup>		 65	 ns
T <sub>f</sub>	Turn-Off Fall Time <sup>3, 4</sup>		 34	
C <sub>iss</sub>	Input Capacitance		 2182	
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ =25V, $V_{GS}$ =0V, f=1MHz	 740	 pF
C <sub>rss</sub>	Reverse Transfer Capacitance		 40	
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz	 0.7	 Ω

#### **Drain-Source Diode Characteristics**

V <sub>SD</sub>	Source to Drain Diode Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> =1A	 	1	V
t <sub>rr</sub>	Reverse Recovery Time	L_20A_di/dt_100A/up	 21		ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>S</sub> =20A, di/dt=100A/us	 8		nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.

2. VDD=50V, VGS=10V, L=0.1mH, RG=25 $\Omega$ , Starting TJ=25°C

3. The data tested by pulsed, pulse width  $\leq$ 300us, duty cycle  $\leq$ 2%.

4. Essentially independent of operating temperature.

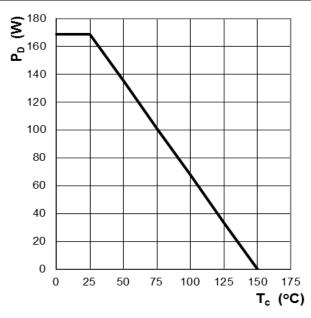
5. Silicon limited

6. Package limited.



## 2. Characteristics Curves









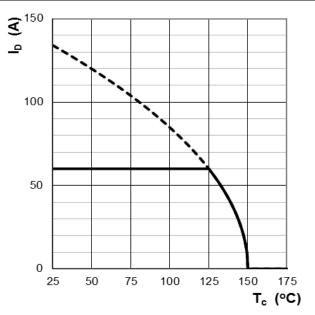


Figure 2: Continuous Drain Current vs. T<sub>c</sub>

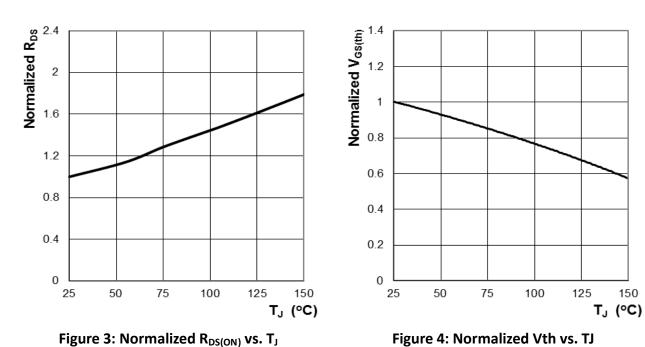


Figure 4: Normalized Vth vs. TJ



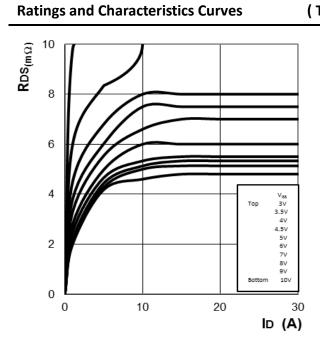


Figure 5: RDS(ON) vs. Drain Current and Gate Voltage

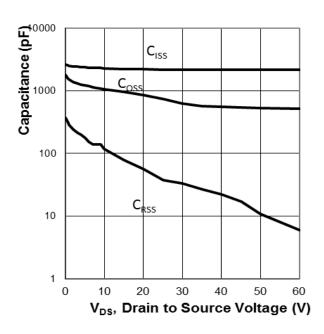


Figure 7: Typ. Capacitance Characteristics

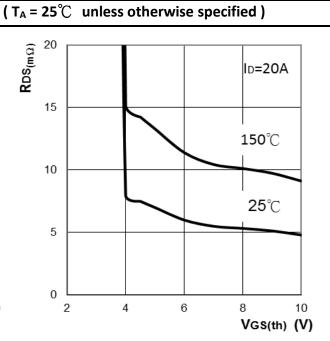


Figure 6: RDS(ON) vs. Gate Voltage

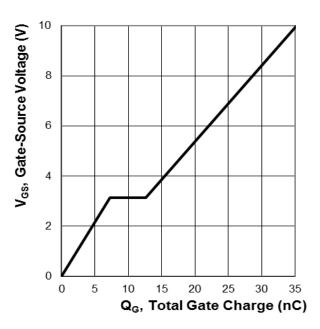


Figure 8: Typ. Gate Charge Characteristics



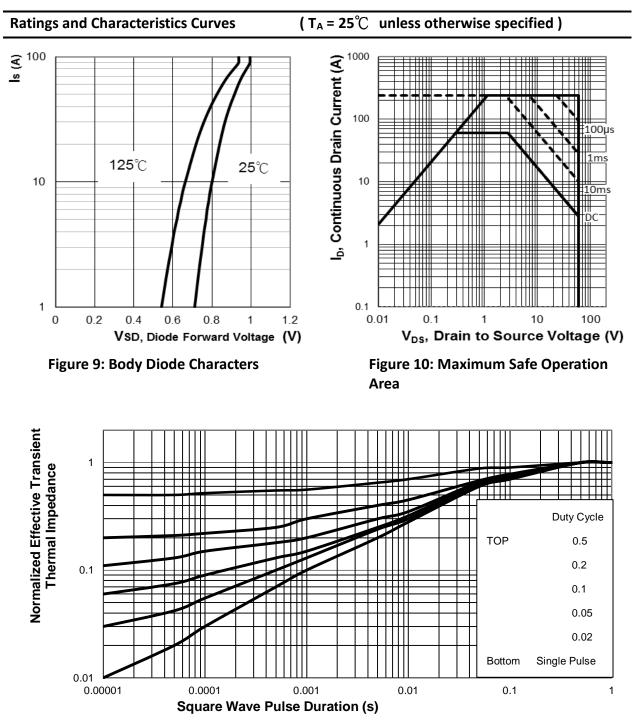
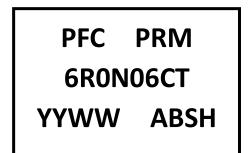


Figure 11: Normalized Thermal Transient Impedance, Junction-to-Case



# 3. Marking information

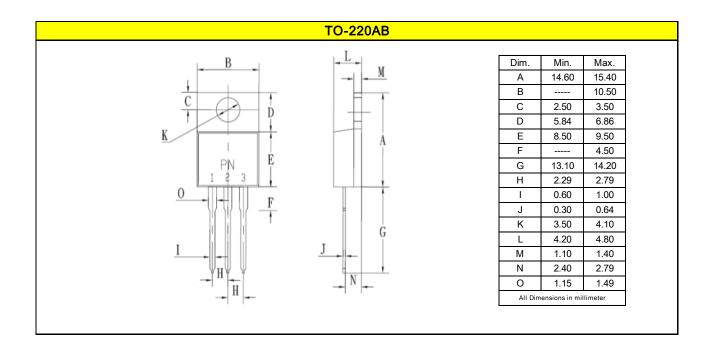
**Top Marking Rule** 



PRM6R0N06CT = Product Type Marking Code YYWW = Date Code YY = Last two digits of year WW = Week code ABS = Assembly code H = Halogen Free (N/A = common molding compound)

## 4. Package information

Package Outline Dimensions millimeters





## 5. Ordering information

Part Number	Package	Delivery mode
PRM6R0N06CT	TO-220AB	50 pcs / Tube

Mechanical

- Molder Plastic: UL Flammability Classification Rating 94V-0
- Device Weight : 0.07 ounces (1.96grams) TO-220ÅB
- Mounting Torque : Recommended 4~5 kg-cm

PFC Device Corp reserves the right to make changes without further notice to any products herein. PFC Device Corp makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does PFC Device Corp assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in PFC Device Corp data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typical" must be validated for each customer application by customer's technical experts. PFC Device Corp does not convey any license under its patent rights nor the rights of others. PFC Device Corp products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the PFC Device Corp product could create a situation where personal injury or death may occur. Should Buyer purchase or use PFC Device Corp products for any such unintended or unauthorized application, Buyer shall indemnify and hold PFC Device Corp and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that PFC Device Corp was negligent regarding the design or manufacture of the part.

